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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/566,099	05/08/2006	Tadahiro Ohmi	039262-0147	9568
	7590 11/24/200 LARDNER LLP	EXAMINER		
SUITE 500	——- T NIW	BIRBACH, NAOMI L		
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			1792	
			MAIL DATE	DELIVERY MODE
			11/24/2009	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		Application No.	Applicant(s)				
Office Action Summary		10/566,099	OHMI ET AL.				
		Examiner	Art Unit				
		NAOMI BIRBACH	1792				
Period fo	The MAILING DATE of this communication ap or Reply	pears on the cover sheet with the c	orrespondence addres	s			
WHIC - Exter after - If NC - Failu Any (ORTENED STATUTORY PERIOD FOR REPLEMENTED IN A STATUTORY PERIOD FOR REPLEMENTED IN A STATUTORY PERIOD FOR REPLEMENT IN A STATUT OR A STATUT	DATE OF THIS COMMUNICATION 136(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	N. nely filed the mailing date of this commur D (35 U.S.C. § 133).				
Status							
1) 又	Responsive to communication(s) filed on 20 s	lulv 2009.					
•		s action is non-final.					
′=	Since this application is in condition for allowa	ance except for formal matters, pro	secution as to the me	rits is			
,—	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositi	ion of Claims						
-	Claim(s) <u>1-16</u> is/are pending in the application	١					
· —	4a) Of the above claim(s) is/are withdrawn from consideration.						
	Claim(s) is/are allowed.						
· · · · · · · · · · · · · · · · · · ·	Claim(s) <u>1-16</u> is/are rejected.						
	Claim(s) is/are objected to.						
8)	Claim(s) are subject to restriction and/o	or election requirement.					
Applicati	on Papers						
	The specification is objected to by the Examin	er					
•	10)⊠ The drawing(s) filed on <u>20 July 2009</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
, , ,	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
	Replacement drawing sheet(s) including the correct			121(d).			
11)	The oath or declaration is objected to by the E	xaminer. Note the attached Office	Action or form PTO-15	52.			
Priority ι	ınder 35 U.S.C. § 119						
· .	Acknowledgment is made of a claim for foreigi ☑ All b)☐ Some * c)☐ None of:		⊢(d) or (f).				
	1. Certified copies of the priority documen						
	2. Certified copies of the priority documen						
	3. Copies of the certified copies of the priority documents have been received in this National Stage						
* ~	application from the International Bureau (PCT Rule 17.2(a)).						
^ 8	See the attached detailed Office action for a lis	t of the certified copies not receive	a.				
Attachmen		A) 🗖 Internation (2)	(DTO 442)				
	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948)	4) ☐ Interview Summary Paper No(s)/Mail Da					
3) 🔲 Inform	mation Disclosure Statement(s) (PTO/SB/08)	5) Notice of Informal P	atent Application				
Pape	r No(s)/Mail Date	6)					

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DETAILED ACTION

Response to Amendment

1. Claims 1-16 are pending. Applicant's amendments in the response filed 7/20/09 are acknowledged.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 5. Claims 1-3 and 14 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over USPA 2002/0005213 to Otsuki.
- 6. It is noted that claim 1 is a product by process claim. Otsuki discloses a silicon carbide product comprising a polycrystalline silicon carbine that is cleaned only by an

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acidic solution and has a surface with a concentration of metal impurities equal or less than 1x10¹¹(atoms/cm³) (Page 1, Paragraphs [0012]-[0013]; Page 7, Paragraph [0075]; Page 8, Paragraph [0093]). In the alternative, because of the nature of product-by process claims, the Examiner cannot ordinarily focus on the precise difference between the claimed product and the disclosed product. It is then Applicants' burden to prove that an unobvious difference exists. See *In re Marosi*, 218 USPQ 289, 292-293 (CAFC 1983). Product-by-process claims are not limited to the manipulations of the recited steps, only the structure implied by the steps (MPEP 2113 [R-1]).

- 7. As to claim 2, Otsuki further discloses that said metal impurities may be Iron, Nickel or Copper (Page 11, Table 1).
- 8. As to claim 3, Otsuki further discloses that the silicon carbide product is a semiconductor device (Page 1, Paragraph [0002]).
- 9. It is noted that claim 14 is a product by process claim. Otsuki discloses a polycrystalline silicon carbide product that is cleaned only by an acidic solution and has a surface concentration of metal impurities equal or less than 1x10¹¹ atoms/cm³ (Page 1, Paragraph [0013]; Page 7, Paragraphs [0075] [0081]; Page 8, Paragraph [0084]). Otsuki discloses that the silicon carbide product is a semiconductor device (Page 1, Paragraph [0002]). In the alternative, because of the nature of product-by process claims, the Examiner cannot ordinarily focus on the precise difference between the claimed product and the disclosed product. It is then Applicants' burden to prove that an unobvious difference exists. See *In re Marosi*, 218 USPQ 289, 292-293 (CAFC 1983).

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Product-by-process claims are not limited to the manipulations of the recited steps, only the structure implied by the steps (MPEP 2113 [R-1]).

- 10. Claims 4-12 are rejected under 35 U.S.C. 102(b) as being anticipated by USPA 2002/0005213 to Otsuki et al.
- 11. As to claim 4, Otsuki discloses a silicon carbide product cleaning method comprising the step of immersing a silicon carbide in an acid, wherein the step of immersing the silicon carbine in the acidic solution reduces surface metal impurities to 1x10¹¹ atoms/cm³ or less (Page 7, Paragraph [0081]; Page 8, Paragraphs [0084], [0093]-[0095]). Otsuki teaches that the silicon carbine is polycrystalline (Page 7, Paragraph [0075]).
- 12. As to claim 5, Otsuki discloses a method of manufacturing a silicon carbide product composed of a polycrystalline silicon carbide, comprising: forming a polycrystalline silicon carbide (Page 7, Paragraph [0075]) and cleaning silicon carbide only with an acidic solution to reduce surface metal impurities to 1x10¹¹ atoms/cm³ or less (Page 1, Paragraph [0013]; Page 8, Paragraphs [0084], [0093]-[0095]).
- 13. As to claim 6, Otsuki further discloses that the acid is hydrochloric or hydrofluoric acid (Page 8, Paragraph [0094]).
- 14. As to claim 7, Otsuki further discloses that said acid is hydrofluoric acid (Page 8, Paragraph [0094]). Otsuki teaches that the concentration of the organic acid is preferably 0.3 to 68% by weight (Page 8, Paragraph [0095]), which exceeds 45%.

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15. As to claim 8, Otsuki further discloses that the hydrofluoric acid (Page 8, Paragraph [0094]) preferably has a concentration of 0.3 to 68% by weight (Page 8, Paragraph [0095]), which includes a concentration of about 50%.

- 16. As to claim 9, Otsuki further discloses that said acid is hydrochloric acid (Page 8, Paragraph [0094]). Otsuki teaches that the concentration of the organic acid is preferably 0.3 to 68% by weight (Page 8, Paragraph [0095]), which exceeds 35%.
- 17. As to claim 10, Otsuki further discloses that the hydrochloric acid (Page 8, Paragraph [0094]) preferably has a concentration of 0.3 to 68% by weight (Page 8, Paragraph [0095]), which includes a concentration of about 36%.
- 18. As to claim 11, Otsuki further discloses that the acid may comprise a mixture of sulfuric acid and hydrogen peroxide (Page 8, Paragraph [0094]).
- 19. As to claim 12, Otsuki does not expressly disclose that the liquid containing said sulfuric acid and said hydrogen peroxide solution has a pH of 4 or less (Page 8, Paragraph [0094]). However, pH is a result effective parameter, because it affects the acidity of the cleaning solution, thus affecting the processing. Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to optimize the method taught by Otsuki in order to enhance cleaning efficiency, consult In re Boesch and Slaney 205 USPQ 215 (CCPA 1980).

Claim Rejections - 35 USC § 103

20. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

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21. Claim 13 is rejected under 35 U.S.C. 103(a) as being unpatentable over USPA 2002/0005213 to Otsuki et al. as applied to claim 12 above, and further in view of USPN 6,348,157 to Ohmi et al.

- 22. Otsuki is relied upon as discussed above with respect to the rejection of Claim 12.
- 23. As to claim 13, Otsuki discloses using sulfuric acid with a concentration of 98% in the cleaning liquid (Page 10, Paragraph [0134]), but does not expressly disclose that the hydrogen peroxide solution has a concentration of about 30% or that the sulfuric acid and hydrogen peroxide are mixed in a volume ratio of 4:1.
- 24. Ohmi discloses a cleaning solution comprising 97% sulfuric acid and 30% hydrogen peroxide mixed in a volumetric ratio of 4:1 (Col. 8, lines 47-51). Ohmi teaches that this solution is used to clean a silicon substrate (Col. 8, lines 47-51).
- 25. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the method taught by Otsuki to include a 97% sulfuric acid and 30% hydrogen peroxide mixed in a volumetric ratio of 4:1 as taught by Ohmi in order to optimize cleaning, as a solution with these properties has been demonstrated to be effective in removing contaminants from a silicon substrate.
- 31. Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over USPA 2002/0005213 to Otsuki et al as applied to claim 11 above, and further in view of USPA 2004/0029392 to Morgan.

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32. Otsuki is relied upon as discussed above with respect to the rejection of Claim

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11.

33. As to claim 12, Otsuki does not expressly disclose that the solution containing sulfuric acid and hydrogen peroxide has a pH of 4 or less.

- 34. Morgan discloses a known cleaning solution of sulfuric acid and hydrogen peroxide which typically has a pH of no greater than 1, which is less than 4 (Page 1, Paragraph [0008]). Morgan teaches that this solution is used to remove metallic contaminants from a substrate surface (Page 1, Paragraphs [0007]-[0008]).
- 35. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the method taught by Otsuki to include a sulfuric acid and hydrogen peroxide solution with a pH of 4 or less as taught by Morgan to optimize cleaning, as a solution with this pH has been demonstrated to be effective in removing contaminants.
- 36. Claim 13 is rejected under 35 U.S.C. 103(a) as being unpatentable over USPA 2002/0005213 to Otsuki et al. in view of USPA 2004/0029392 to Morgan as applied to claim 12 above, and further in view of USPN 6,348,157 to Ohmi et al.
- 37. Otsuki and Morgan are relied upon as discussed above with respect to the rejection of Claim 12.
- 38. As to claim 13, the combination of Otsuki and Morgan does not expressly disclose that the sulfuric acid and hydrogen peroxide solution respectively have concentrations of about 97% and about 30% and are mixed in a volume ratio of 4:1.

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39. Ohmi discloses a cleaning solution comprising 97% sulfuric acid and 30% hydrogen peroxide mixed in a volumetric ratio of 4:1 (Col. 8, lines 47-51). Ohmi teaches that this solution is used to clean a silicon substrate (Col. 8, lines 47-51).

- 40. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the method taught by Otsuki and Morgan to include a 97% sulfuric acid and 30% hydrogen peroxide mixed in a volumetric ratio of 4:1 as taught by Ohmi in order to optimize cleaning, as this solution has been demonstrated to be effective in removing contaminants from a silicon substrate.
- 41. Claims 15 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over USPA 2002/0005213 to Otsuki et al. as applied to claim 5 above, and further in view of "Applications of High Purity SiC Prepared by Chemical Vapor Deposition" to Chinone et al.
- 42. Otsuki is relied upon as discussed above with respect to the rejection of claim 5.
- 43. As to claims 15 and 16, Otsuki further discloses that the polycrystalline silicon carbine is formed over a graphite base member (Page 6, Paragraph [0068]; Page 7, Paragraph [0075]). Otsuki does not expressly disclose that the silicon carbine layer is grown by a CVD method over a base member where the silicon carbine layer is separated by burning out the graphite base member.
- 44. Chinone discloses that it is known to grown silicon carbine layers on graphite bases by a CVD method, followed by separating the silicon carbine layer from the

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graphite base member by burning out the graphite base member to form the silicon carbide product (Page 198).

45. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the method taught by Otsuki to include growing the crystalline silicon carbide over a graphite base by a CVD method as taught by Chinone for the benefit of producing a silicon carbine product with low impurity levels, near theoretical density and good adherence (Page 198, Introduction).

Response to Arguments

- 46. Applicant's arguments filed 7/20/09 have been fully considered but they are not persuasive.
- 47. In response to applicant's argument that the references fail to show certain features of applicant's invention, it is noted that the features upon which applicant relies (i.e., physical and chemical characteristics of single-crystalline or polycrystalline silicon carbine such as density, porosity) are not recited in the rejected claim(s). Although the claims are interpreted in light of the specification, limitations from the specification are not read into the claims. See *In re Van Geuns*, 988 F.2d 1181, 26 USPQ2d 1057 (Fed. Cir. 1993). Otsuki teaches that the sintered silicon carbine is polycrystalline (Page 7, Paragraph [0075]), thus it reads on the claim limitations.
- 48. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention

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where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, the properties of the solutions taught by Morgan and Ohmi would reasonably be expected to remove metallic contaminants from silicon carbide since Otsuki teaches using a solution of sulfuric acid and hydrogen peroxide to clean silicon carbide of metal contaminants (Page 8, Paragraphs [0093]-[0094]) . Furthermore, it was not suggested to apply the cleaning process taught by Otsuki et al. to silicon.

49. Applicant argues that a plurality of cleaning steps must be performed in Otsuki's method in order to obtain a silicon carbide with a surface cleanliness of less than $1 \times 10^{11} (atoms/cm^3)$. However, the claims recite the transitional term "comprising", which is inclusive or open-ended and does not exclude additional, unrecited elements or method steps. See MPEP 2113.03 [R-3]. Even if other cleaning steps are performed, it is only because of the acidic solution that the metal impurities are reduced to less than $1 \times 10^{11} atoms/cm^3$ (Page 8, Paragraph [0093]-[0095]).

Conclusion

50. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

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A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

- 52. Any inquiry concerning this communication or earlier communications from the examiner should be directed to NAOMI BIRBACH whose telephone number is (571)270-7367. The examiner can normally be reached on Monday-Friday, 8:00am-5:30pm.
- 53. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Kornakov can be reached on 571-272-1303. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.
- 54. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic

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Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/N. B./
Examiner, Art Unit 1792
/Michael Kornakov/
Supervisory Patent Examiner, Art Unit 1792